

04-29-2010

U.S. DEPARTMENT OF COMMERCE
United States Patent and Trademark Office



103595922

To the Director of the U.S. Patent and

ments or the new address(es) below.

1. Name of conveying party(ies)

Voya Markovich
Timothy Antesberger
Frank D. Egitto
William E. Wilson
Rabindra N. Das

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies)

Name: Endicott Interconnect Technologies, Inc.

Internal Address:

Street Address: 1093 Clark Street

City: Endicott

State: New York

Country: US

Zip: 13760

Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s) 2/28/2010; 3/2/2010; 3/4/2010

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Joint Research Agreement

☐ Government Interest Assignment

☐ Executive Order 9424, Confirmatory License

☐ Other

4. Application or patent number(s):

A. Patent Application No.(s)

☒ This document is being filed together with a new application.

B. Patent No.(s)

APR 22 2010

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Mark Levy

Internal Address: HINMAN, HOWARD & KATTELL, LLP

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6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00

☒ Authorized to be charged to deposit account

☐ Enclosed

☐ None required (government interest not affecting title)

8. Payment Information

Deposit Account Number 503721

Authorized User Name Mark Levy

9. Signature:

/Mark Levy/
Signature

4/22/2010
Date

Mark Levy
Name of Person Signing

Total number of pages including cover sheet, attachments, and documents.

3

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, VA 22313-1450

04/26/2010 NJANA1 00000003 503721 12764997

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**Assignment of Rights, Title and Interest in Invention
(Multiple inventors; single assignee)**

Docket No.
EI-2-08-021-3

This is an Assignment of the following rights, title and interest: (check all that apply):

☒ *United States of America rights, title and interest in the invention*

☐ *Foreign rights, title and interest in the invention*

☐ *United States Patent Application Serial No. _____*

Date of Execution: _____ Date of Filing: _____

☐ *United States Provisional Patent Application Serial No. _____*

☐ *United States Patent No(s). _____*

☐ *International (PCT) Patent Application Serial No. _____*

☐ *Other (specify) _____*

Title of the Invention

CORELESS LAYER BUILDUP STRUCTURE WITH LGA AND JOINING LAYER

Inventors (assignors)

<i>Name</i>	<i>Address</i>
Timothy Antesberger	308 Schubmehl Road, Vestal, New York 13850
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William E. Wilson	410 Acres Avenue, Waverly, New York 14892

Assignee

<i>Name</i>	<i>Address</i>
Endicott Interconnect Technologies, Inc.	1093 Clark Street Endicott, New York 13760

Assignment of Rights, Title and Interest in Invention
(Multiple inventors; single assignee)

Docket No.
EI-2-08-021-3

Whereas, we, the above-identified Inventors, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and/or patent(s) (hereinafter referred to as "Invention");

And, whereas we desire to assign our above-identified rights, title and interest in the Invention to the above-identified Assignee;

Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

We hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said application(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted or have granted for said Invention, and in and to any and all reissues and reexaminations thereof, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto said Assignee;

And we hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

And we further agree to sign and execute all necessary and lawful future documents, including applications for foreign patents, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

Inventors' Signatures (if Notarization is desired, do not sign here and proceed to next page)


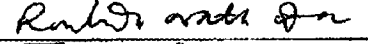



Name	Signature/Date
Timothy Antesberger	 3/2/2010
Rabindra N. Das	 3/4/2010
Frank D. Egitto	 2/28/10
Voya R. Markovich	 3/4/2010
William E. Wilson	 3-4-2010

Table of Contents (Selected Documents)

Date	Code	Pages	Source	PackageID	Annotation
04-22-2010	R3.73B	3	EFSW	US 1276499701P1	